

Introduction

Thank you for participating in the Kintex™-7 FPGAs Engineering Sample Program. As part of this program, we are pleased to provide to you engineering samples of the devices listed in [Table 1](#). Although Xilinx has made every effort to ensure the highest possible quality, these devices are subject to the limitations described in the following errata.

Devices

These errata apply to the devices shown in [Table 1](#).

Table 1: Devices Affected by These Errata

| Product Family | Device | JTAG ID (Revision Code) | Packages | Speed Grades | Temperature |
|----------------|------------------|----------------------------|----------|--------------|--------------|
| Kintex-7 | XC7K325T CES9925 | 3 | All | -1, -2 | 0°C to 100°C |
| | XC7K410T CES9925 | 0 | | | |
| | XC7K420T CES9925 | 1 | | | |
| | XC7K480T CES9925 | 1 | | | |

Hardware Errata Details

This section provides a detailed description of each hardware issue known at the release time of this document.

Single Block RAM Location Not Available (Applies only to XC7K410T Device)

For only the XC7K410T device listed in [Table 1](#), the 36K block RAM location at x4Y11 is not available for use. Use the CONFIG PROHIBIT=RAMB36_X4Y11 constraint in the UCF file to prevent the design tools from using this block RAM location.

XADC

For improved linearity, a new BitGen option (XADCEnhancedLinearity = ON/OFF) must be set to ON (see [Answer Record 45781](#) for more information). The specifications enhanced by this BitGen option are INL, THD, and SNR (see [Table 2](#)). By default this BitGen option is set to OFF. Existing XADC designs operate with the OFF setting.

[Table 2](#) also lists errata for XADC DC accuracy specifications of Offset Error, Gain Error, Channel Matching, and On-Chip Reference Variation.

Table 2: XADC Errata

| Parameter | XADC Errata | | DS182 (v1.4), Kintex-7 FPGAs Data Sheet: DC and Switching Characteristics Specifications |
|---------------------------------|----------------------------|-----------------------------|--|
| | XADCEnhancedLinearity = ON | XADCEnhancedLinearity = OFF | |
| Integral Nonlinearity (INL) | ±3 LSBs Max | ±5 LSBs Max | ±2 LSBs Max |
| Total Harmonic Distortion (THD) | 70 dB Typ | 65 dB Typ | 75 dB Min |
| Signal to Noise Ratio (SNR) | 60 dB Min | 60 dB Typ | 60 dB Min |

Table 2: XADC Errata (Cont'd)

| Parameter | XADC Errata | | DS182 (v1.4), Kintex-7 FPGAs Data Sheet: DC and Switching Characteristics Specifications |
|--|----------------------------|-----------------------------|--|
| | XADCEnhancedLinearity = ON | XADCEnhancedLinearity = OFF | |
| Channel Matching | 11 LSBs Max | 11 LSBs Max | 10 LSBs Max |
| Offset Error | ±6 LSBs Max | ±6 LSBs Max | ±4 LSBs Max |
| Gain Error | ±0.5% Max | ±0.5% Max | ±0.4% Max |
| On-Chip Reference Variation ⁽¹⁾ | 1.25V ±1.5% Max | 1.25V ±1.5% Max | 1.25V ±1.0% Max |

Notes:

1. See [Answer Record 44971](#) for more information on the impact to XADC measurements when the on-chip reference source is used.

[DS182](#), *Kintex-7 FPGAs Data Sheet: DC and Switching Characteristics* specifications will be updated to reflect the final device characterization.

GTX Transceivers

QPLL Upper Band Usage (Applies only to the XC7K410T, XC7K420T, and XC7K480T Devices)

When using the QPLL upper band VCO mode (QPLL_CFG[6]=0), the MGTAVCC power supply must be 1.05V ±30mV.

The operating frequency range ($F_{GCPLL\text{RANGE}2}$) of the QPLL upper band VCO mode (QPLL_CFG[6]=0) is 9.94 GHz to 10.3125 GHz. Due to this limitation, GTX transceiver data rates between 9.80 Gb/s to 9.93 Gb/s are not supported.

Out-of-Band Signaling

The GTX transceiver circuitry for out-of-band (OOB) signaling is always enabled.

CPLL Power Down

The GTX transceiver CPLL can become inoperative if conditions (1) and (2) persist for more than 8,000 hours:

1. Power has been applied to MGTAVCC and MGTAVTT.
2. The device is in one of the following states:
 - a. The FPGA is not configured.
 - b. The FPGA is configured, but the transceiver is uninstantiated.
 - c. The transceiver is instantiated, but the CPLL is held in power-down state.

When the QPLL is being used, enabling each CPLL will consume up to 30 mA on the MGTAVTT supply and 20 mA on MGTAVCC. See [Answer Record 45360](#) for more details.

GTX Transceiver Power-On/Power-Off

The recommended power-on sequence is MGTAVCC before MGTAVTT, and the recommended power-off sequence is MGTAVTT before MGTAVCC.

If the recommended power sequences are not followed, then the GTX transceiver can become inoperative if both of the following conditions occur at the same time:

- MGTAVTT is within its recommended operating range
- MGTAVCC is at a voltage less than 0.4V for more than 10,000 cumulative hours

An additional 100 mA per transceiver is drawn from MGTAVTT when MGTAVTT is within its recommended operating range and MGTAVCC is at a voltage of 0.4V or less.

For only the XC7K420T and XC7K480T devices, an additional 300 mA per transceiver can be drawn from MGTAVTT when MGTAVTT is within its recommended operating range and MGTAVCC is transitioning through 0.4V.

IEEE Std 1149.6 for GTX Transceivers

In the devices listed in [Table 1](#), IEEE Std 1149.6 (ACJTAG) boundary-scan test commands EXTEST_PULSE and EXTEST_TRAIN are not supported.

Power

Static Power

All power supplies can exhibit up to 25% higher static current compared to the static current reported in XPE.

Also, up to an additional 30 mA per used transceiver, and up to an additional 50 mA per powered transceiver Quad can be consumed by the MGTAVCC supply. And, up to an additional 50 mA per powered transceiver Quad can be consumed by the MGTAVTT supply.

Design Software Requirements

The devices listed in [Table 1](#), unless otherwise specified, require the following Xilinx Design Tools:

- Speed specification v1.03 (or later) of Xilinx® ISE® Design Suite 13.4 (or later) available at <http://www.xilinx.com/support/download/>.
- For GTX transceiver attribute updates, refer to [Answer Record 45360](#).
- See Kintex-7 FPGA [Answer Record 45696](#) for known issues and work-arounds for Xilinx Design Tools.

Operational Guidelines

Physical Interface Rate for Memory Interfaces

Designs targeting DDR3 data rates above 800 Mb/s should include an external V_{REF} . For further details, refer to [Answer Record 42036](#).

Hardware Validation for Memory Interfaces

The memory interfaces listed in [Table 3](#) have been validated in hardware across the operating conditions for these devices at the time of publication. See [Answer Record 46521](#) for the latest hardware validation information.

Table 3: Hardware Validated Memory Interfaces

| Type | Condition | Bank |
|--------|--------------------------------|-----------|
| DDR3 | DIMM and Component Single Rank | HP and HR |
| QDRII+ | Component Single Rank | HP |

Traceability

Figure 1 shows an example device top mark for the devices listed in Table 1.

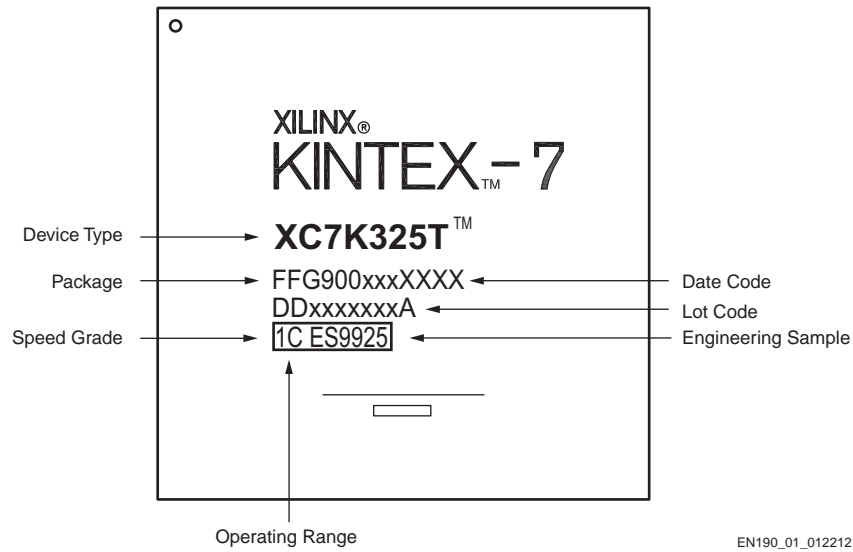


Figure 1: Example Device Top Mark

Additional Questions or Clarifications

For additional questions regarding these errata, contact Xilinx Technical Support: <http://www.xilinx.com/support/clearxpress/websupport.htm> or your Xilinx Sales Representative: <http://www.xilinx.com/company/contact/index.htm>.

Revision History

The following table shows the revision history for this document:

| Date | Version | Description of Revisions |
|----------|---------|--|
| 01/24/12 | 1.0 | Initial Xilinx release. |
| 03/13/12 | 1.1 | Added additional devices to Table 1 . Removed Dual Rank for DDR3 and DDR2; silicon support for dual-rank reinstated. Added Single Block RAM Location Not Available (Applies only to XC7K410T Device) . Updated Table 2 . Added QPLL Upper Band Usage (Applies only to the XC7K410T, XC7K420T, and XC7K480T Devices) . Updated Static Power . Updated Operational Guidelines: removed Operational Guidelines for DDR3 and DDR2; added Physical Interface Rate for Memory Interfaces and Hardware Validation for Memory Interfaces . |
| 04/05/12 | 1.2 | Updated GTX Transceiver Power-On/Power-Off . |

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